onsemi

<u>MOSFET</u> – N-Channel, SUPERFET[®] II

800 V, 17 A, 290 m Ω

FCPF290N80

Description

SuperFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

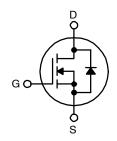
Features

- Typ. R_{DS(on)} = 0.245 Ω
- Ultra Low Gate Charge (Typ. Q_g = 58 nC)
- Low E_{oss} (Typ. 5.6 µJ @ 400 V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 240 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

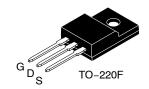
Applications

- AC-DC Power Supply
- LED Lighting

V _{DSS} R _{DS(ON)} MAX		I _D MAX	
800 V	290 mΩ @ 10 V	17 A	

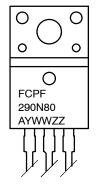


N-Channel MOSFET



TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT

MARKING DIAGRAM



FCPF290N80= Specific Device Code

A	= Assembly Location
YWW	= Date Code (Year & Work Week)
ZZ	= Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping		
FCPF290N80	TO-220-3 (Pb-Free)	1000 Units / Tube		

Symbol	Parameter Drain to Source Voltage		FCPF290N80	Unit	
V _{DSS}			800	V	
V _{GSS}	Gate to Source Voltage	– DC	±20	V	
		– AC (f > 1 Hz)	±30	1	
ID	Drain Current	– Continuous (T _C = 25°C)	17*	А	
		– Continuous (T _C = 100°C)	10.8*	1	
I _{DM}	Drain Current	- Pulsed (Note 1)	42*	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		882	mJ	
I _{AR}	Avalanche Current (Note 1)		3.4	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.12	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		20	1	
PD	Power Dissipation	(T _C = 25°C)	40	W	
		– Derate above 25°C	0.32	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse width limited by maximum junction temperature. 2. $I_{AS} = 3.4 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$ 3. $I_{SD} \le 17 \text{ A}, \text{ di/dt} \le 200\text{A/}\mu\text{s}, V_{DD} \le BV_{DSS}, \text{ starting } T_J = 25^{\circ}\text{C}$

THERMAL CHARACTERISTICS

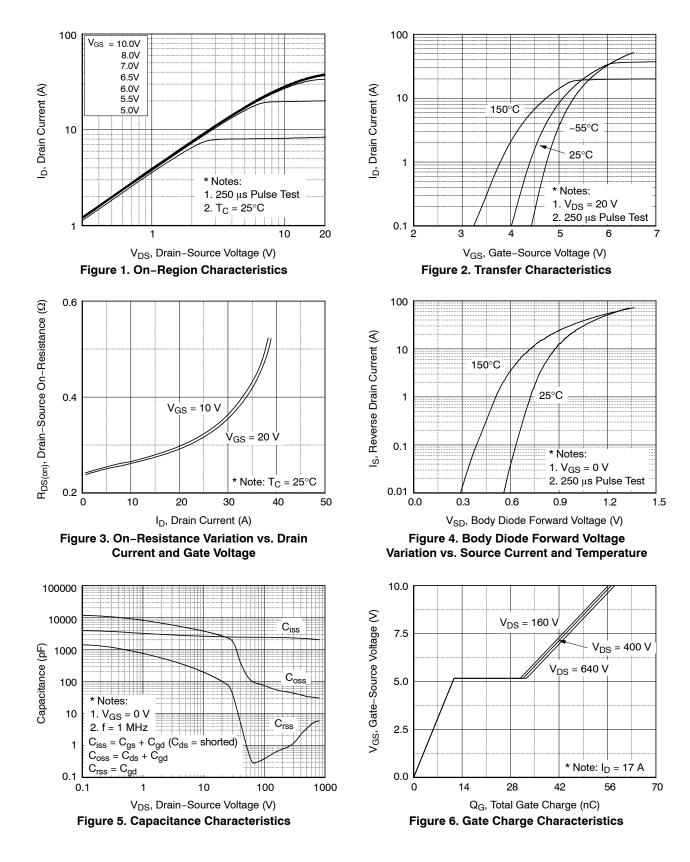
Symbol	Characteristic	FCPF290N80	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.15	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

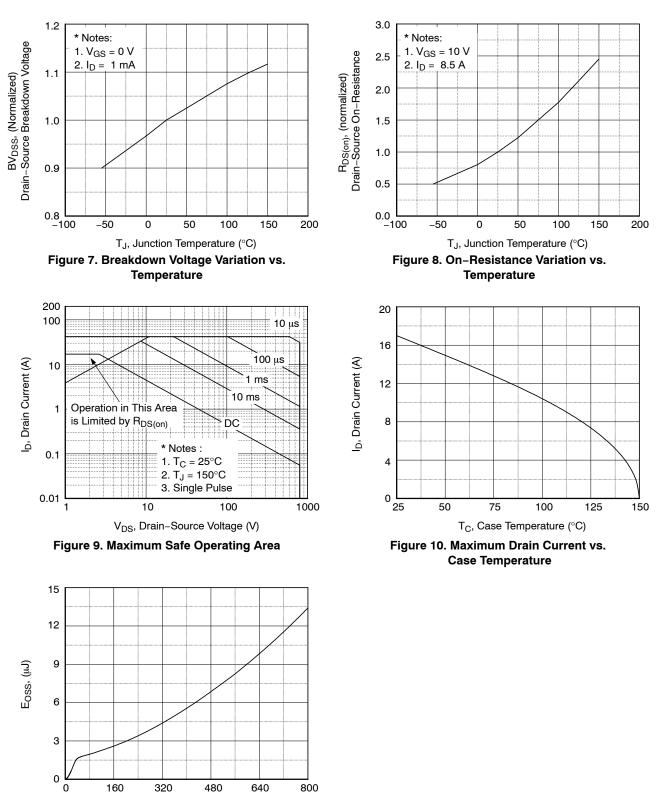
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	800	-	-	V
$\Delta \text{BV}_{\text{DSS}}$ / $\Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1 \text{ mA}$, Referenced to 25°C	-	0.8	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25	μA
		$V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	-	250	1
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARA	ACTERISTICS					
V _{GS(th})	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 1.7 \text{ mA}$	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$	-	245	290	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$	-	20	-	S
OYNAMIC	CHARACTERISTICS	•	-	-	•	-
C _{iss}	Input Capacitance	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz	-	2410	3205	pF
C _{oss}	Output Capacitance		_	75	100	pF
C _{rss}	Reverse Transfer Capacitance		_	0.36	-	pF
C _{oss}	Output Capacitance	V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz	-	35	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	-	240	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 640 \text{ V}, I_D = 17 \text{ A}, V_{GS} = 10 \text{ V}$ (Note 4)	-	58	75	nC
Q _{gs}	Gate to Source Gate Charge		_	11	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	7	-	22	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.75	-	Ω
WITCHIN	G CHARACTERISTICS	•	•		•	
t _{d(on)}	Turn-On Delay Time	V_{DD} = 400 V, I _D = 17 A, V _{GS} = 10 V,	-	22	54	ns
t _r	Turn–On Rise Time	R _G = 4.7 Ω (Note 4)	-	14	38	ns
t _{d(off)}	Turn–Off Delay Time		-	61	132	ns
t _f	Turn-Off Fall Time	7	-	2.6	15	ns
DRAIN-SO	DURCE DIODE CHARACTERISTICS	-		-		-
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	17	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	42	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 17 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 17 A,	-	511	-	ns
Q _{rr}	Reverse Recovery Charge	dl _F / dt = 100 A/μs		12	<u> </u>	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics

TYPICAL PERFORMANCE CHARACTERISTICS



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



V_{DS}, Drain to Source Voltage (V)

Figure 11. E_{oss} vs. Drain to Source Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

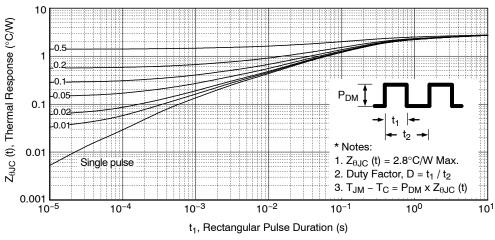
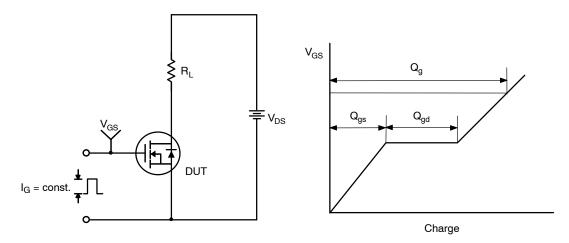


Figure 12. Transient Thermal Response Curve





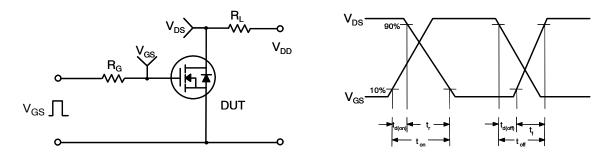


Figure 14. Resistive Switching Test Circuit & Waveforms

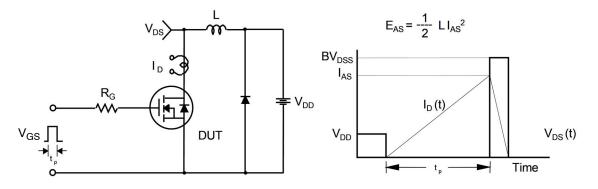


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

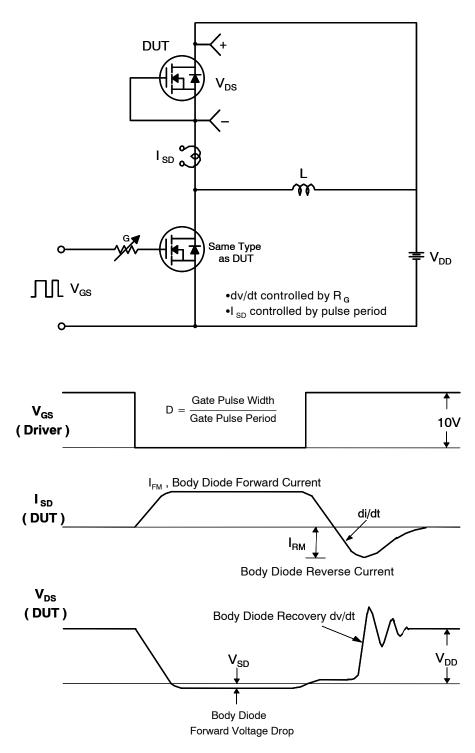
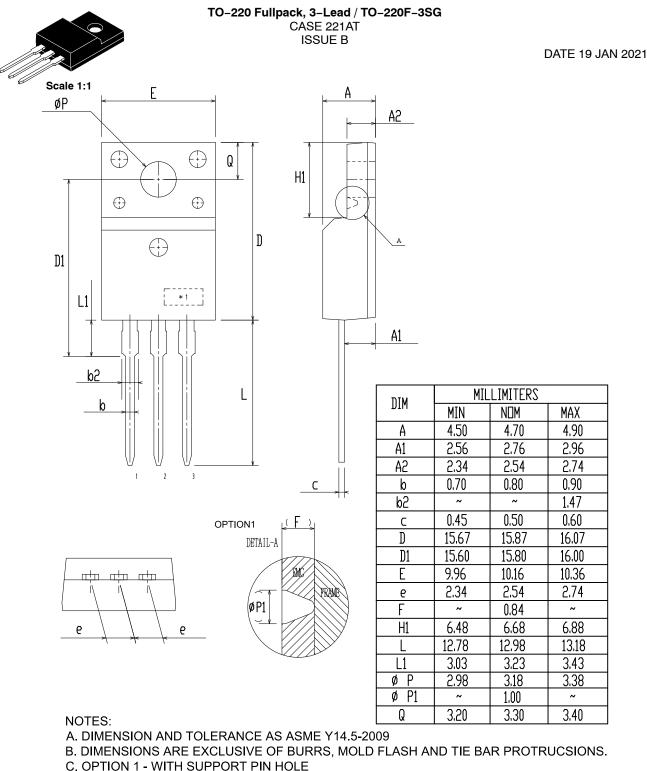


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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OPTION 2 - NO SUPPORT PIN HOLE

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DESCRIPTION:	TO-220 FULLPACK, 3-LEAD / TO-220F-3SG		PAGE 1 OF 1	

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